



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of
Werner PLASS et al.

Serial No.: 10/631,384

Filed: July 31, 2003

For: Surface Emitting Semiconductor Laser Chip and
Method for Producing the Chip

Mail Stop RCE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Examiner: SEFER, Ahmed N.
Group Art: 2826

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Mail Stop RCE, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on

April 23, 2007
(Date of Deposit)

Thomas Langer
Name of applicant, assignee or Registered Representative

Signature

April 23, 2007
Date of Signature

AMENDMENT UNDER 37 C.F.R. § 1.114

Sir:

In conjunction with a Request for Continued Examination, this paper is submitted in response to the Advisory Action mailed March 21, 2007 and the Final Office Action dated October 23, 2006, please amend the above-identified application as follows:

Amendments to the Drawings begin on page 2 of this paper.

Amendments to the Claims begin on page 3 of this paper.

Remarks/Arguments begin on page 7 of this paper.

Amendments to the Drawings:

Please replace Fig. 2 with the attached replacement sheet.

The attached sheet of drawings includes changes to Fig. 2.

The replacement sheet includes Figs. 1 and 2 and replaces the original sheet that includes Figs. 1 and 2.

Attachment: Replacement Sheet.